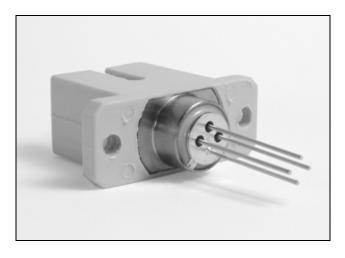


# 1.25 Gbps, 1310 nm Uncooled Fabry-Perot Laser Diode Module with Monitor

**Data Sheet** 

December 2003



#### **Features**

- Uncooled 1300 nm Fabry-Perot Laser Diode
- Wide operating temperature range -40°C to +85°C
- High reliability
- · Built-in monitor diode
- 1.25 Gbps
- · Ball lens or receptable type of packaging

#### **Applications**

- Fiber Channel and Gigabit Ethernet applications up to 1.25 Gbps
- · Optical communications systems

#### **Ordering Information**

ZL60404TBD TO-56 with lens
ZL60404TDD ST type connector
ZL60404TED SC type connector
ZL60404TFD FC type connector

-40°C to +85°C

#### Description

The Fabry-Perot Laser Diode Receptacle type series is designed for use with SC, FC and ST type fiber connectors as source in telecom and datacom applications.

The ZL60404 is a 1310 nm MQW (Multiple Quantum Well) Fabry-Perot laser diode, integrated with a monitor diode.

The hermatically sealed package includes a ball lens for improved coupling efficiency.

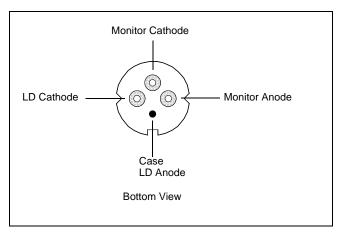


Figure 1 - PIN Diagram

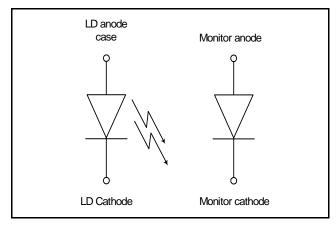


Figure 2 - Functional Schematic

ZL60404 Data Sheet

# Electrical and Optical Characteristics ( $T_C = 25^{\circ}C$ )

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Threshold Current	I <sub>th</sub>	CW		10	15	mA
Operating Voltage	V <sub>op</sub>	CW, $I_f = I_{th} + 20 \text{ mA}$		1.3	1.5	V
Optical Output Power	P <sub>f</sub>	CW, $I_f = I_{th} + 20 \text{ mA}$		0.6		mW
Wavelength	λ	CW, I <sub>th</sub> +20 mA	1290	1310	1330	nm
Spectral Width	Δλ	CW, I <sub>th</sub> +20 mA		1	3	nm
Rise and Fall Times	t <sub>r</sub> , t <sub>f</sub>	$I_f = I_{th} + 20 \text{ mA},$ 20-80%			300	ps
Tracking Error	$\Delta P_f / P_f$	APC, 0 - +70°C	-1.5		1.5	dB
		-40°C - +85°C	-2.5		2.5	
Monitor Current	I <sub>D</sub>	CW, $I_{th}$ +20 mA, $V_{RD}$ = 1 V	100			μΑ
Monitor Dark Current	I <sub>D</sub>	V <sub>RD</sub> = 5 V			1	μA
Monitor Capacitance	C <sub>D</sub>	V <sub>RD</sub> = 5 V, f = 1 MHz		10	15	pF

#### **Absolute Maximum Ratings**

Parameter	Symbol	Rating	Unit
LD Reverse Voltage	V <sub>RL</sub>	2	V
PD Reverse Voltage	V <sub>RD</sub>	20	V
PD Forward Current	I <sub>f</sub>	2.0	mA
Operating Temperature	T <sub>op</sub>	-40 - +85	°C
Storage Temperature	T <sub>stg</sub>	-40 - +85	°C

ZL60404 Data Sheet

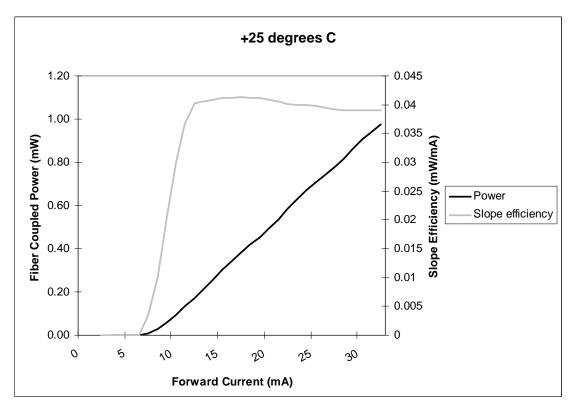


Figure 3 - Typical Fiber Coupled Power and Slope Efficiency at Room Temperature

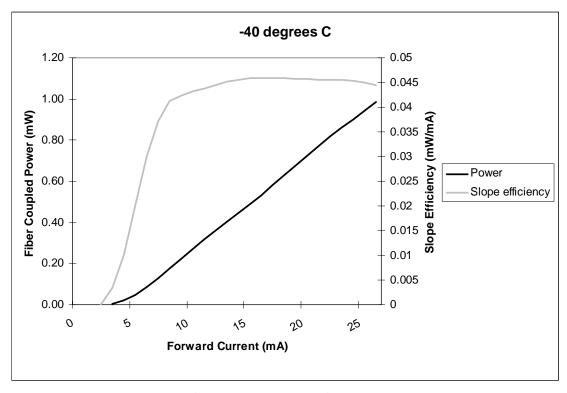


Figure 4 - Typical Fiber Coupled Power and Slope Efficiency at Low Temperature

ZL60404 Data Sheet

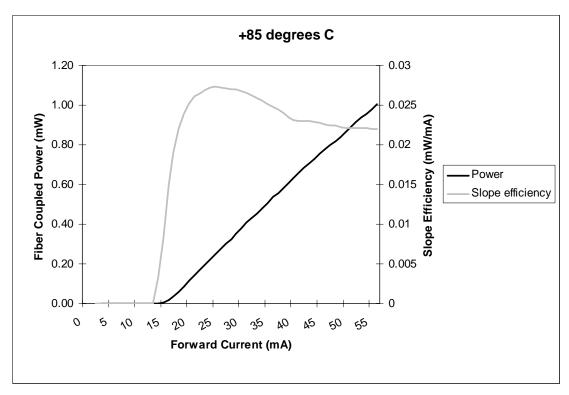
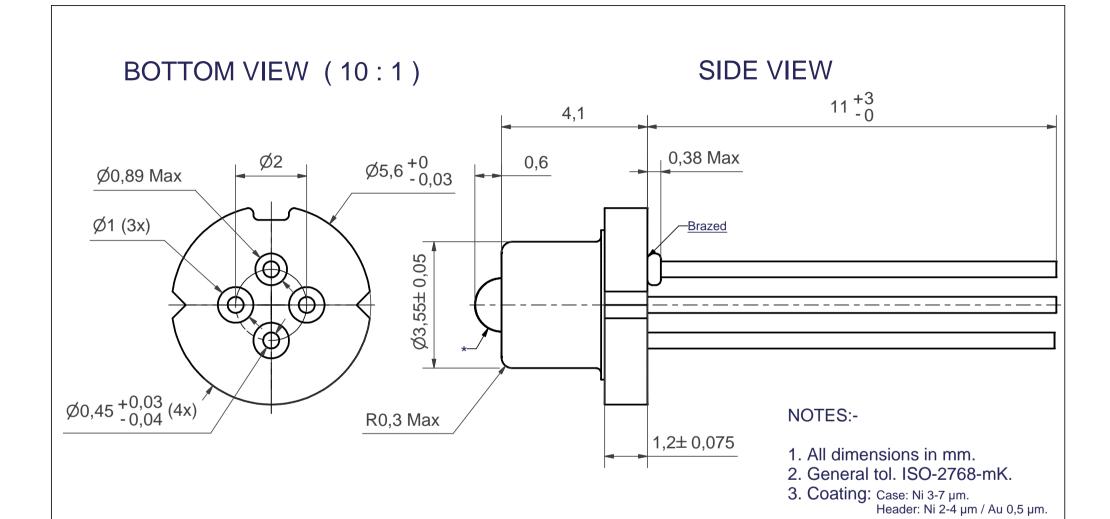


Figure 5 - Typical Fiber Coupled Power and Slope Efficiency at High Temperature



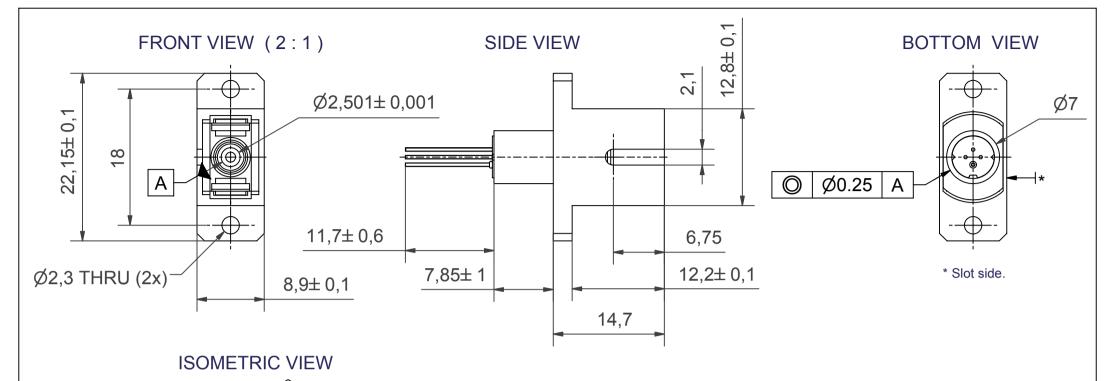
\* Lens Ø1,5± 0,002

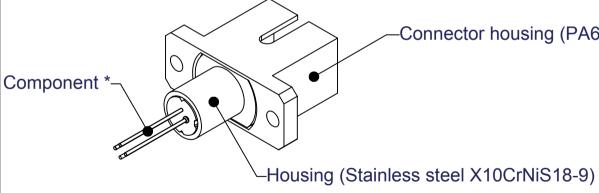
Projection Method

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ISSUE	1							
ACN	101615 rev1							
DATE	21-NOV-03							
APPRD.	MD/MA							



	Package code TB
Previous package codes	Drawing type Package Drawing, TO-56 with lens
	Title 101615





-Connector housing (PA66, 13% Glass fibre)

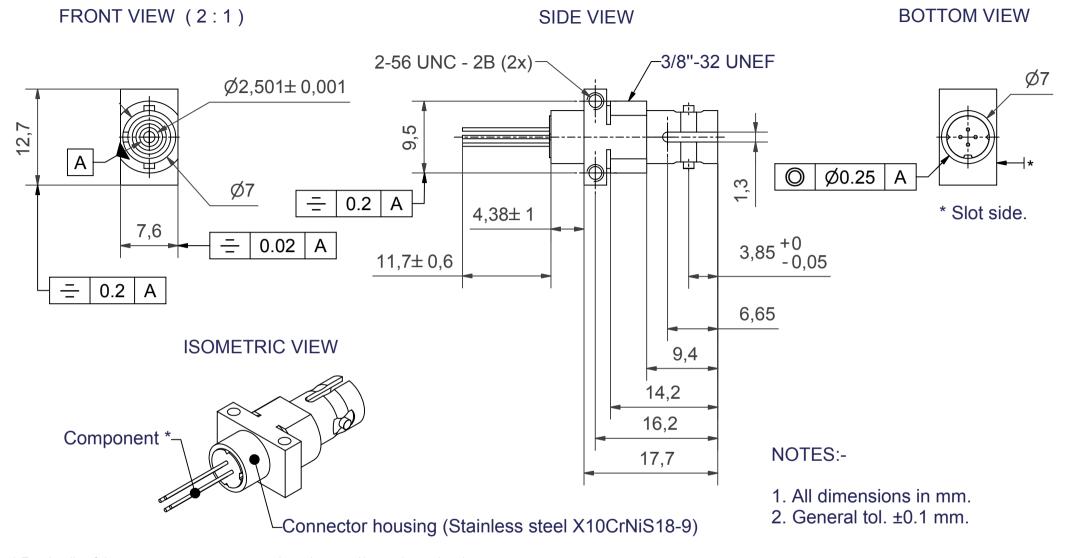
### **NOTES:-**

- 1. All dimensions in mm.
- 2. General tol. ISO-2768-mK.



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ISSUE	1					Previous package codes	Drawing type
ACN	101512rev 1				<b>ZARLINK</b>		TO-56 Package Outline in SC Connector housing
DATE	17-NOV-03				SEMICONDUCTOR		Title
APPRD.	PD\US						101512

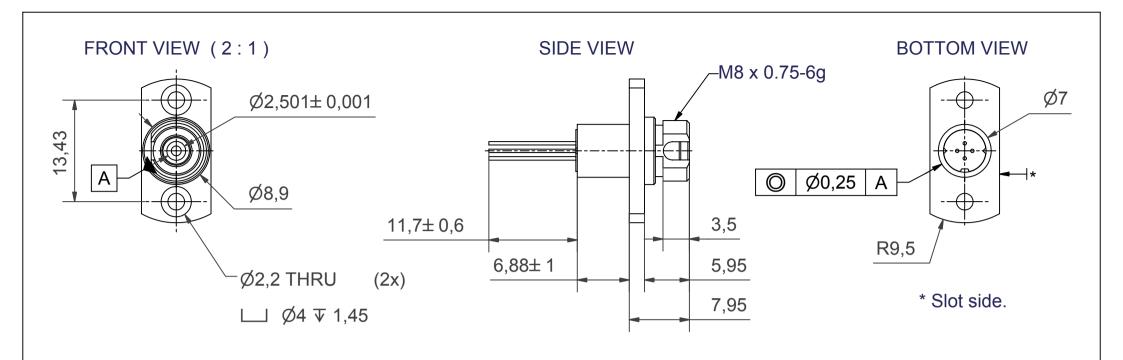
<sup>\*</sup> For details of the component, see separate data sheet and/or package drawing.



<sup>\*</sup> For details of the component, see separate data sheet and/or package drawing.



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ACN	101514 rev1				<b>EXECUTE</b> ZARLINK		TO-56 Package Outline in ST Connector housing
DATE	17-NOV-03				SEMICONDUCTOR		Title
APPRD.	PD\US						101514



# ISOMETRIC VIEW



# **NOTES:-**

- 1. All dimensions in mm.
- 2. General tol. ISO-2768-mK.

Projection 🚭

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ISSUE	1					Previous package codes	Drawing type
ACN	101513 rev1				<b>ZARLINK</b>		TO-56 Package Outline in FC Connector housing
DATE	17-NOV-03				SEMICONDUCTOR		Titlo
APPRD.	PD\US						101513

<sup>\*</sup> For details of the component, see separate data sheet and/or package drawing.



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